UNR221x Series (UN221x Series)

Silicon NPN epitaxial planar transistor

For digital circuits

■ Features

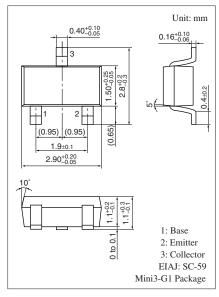
- Costs can be reduced through downsizing of the equipment and reduction of the number of parts.
- Mini type package allowing easy automatic insertion through tape packing and magazine packing

■ Resistance by Part Number

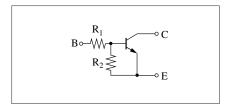
	Mar	king Syr	(R_2)	
• UNR2210	(UN2210)	8L	$47~\mathrm{k}\Omega$	_
• UNR2211	(UN2211)	8A	$10~\mathrm{k}\Omega$	$10~\mathrm{k}\Omega$
• UNR2212	(UN2212)	8B	$22~\mathrm{k}\Omega$	$22~k\Omega$
• UNR2213	(UN2213)	8C	$47~\mathrm{k}\Omega$	$47~\mathrm{k}\Omega$
• UNR2214	(UN2214)	8D	$10~\mathrm{k}\Omega$	$47~\mathrm{k}\Omega$
• UNR2215	(UN2215)	8E	$10~\mathrm{k}\Omega$	_
• UNR2216	(UN2216)	8F	$4.7~\mathrm{k}\Omega$	_
• UNR2217	(UN2217)	8H	$22~\mathrm{k}\Omega$	_
• UNR2218	(UN2218)	8I	$0.51~\mathrm{k}\Omega$	$5.1~\mathrm{k}\Omega$
• UNR2219	(UN2219)	8K	$1 \text{ k}\Omega$	$10~\mathrm{k}\Omega$
• UNR221D	(UN221D)	8M	$47~\mathrm{k}\Omega$	$10~\mathrm{k}\Omega$
• UNR221E	(UN221E)	8N	$47~\mathrm{k}\Omega$	$22~k\Omega$
• UNR221F	(UN221F)	8O	$4.7~\mathrm{k}\Omega$	$10~\mathrm{k}\Omega$
• UNR221K	(UN221K)	8P	$10~\mathrm{k}\Omega$	$4.7~\mathrm{k}\Omega$
• UNR221L	(UN221L)	8Q	$4.7~\mathrm{k}\Omega$	$4.7~\mathrm{k}\Omega$
• UNR221M	(UN221M)	EL	$2.2~\mathrm{k}\Omega$	$47~\mathrm{k}\Omega$
• UNR221N	(UN221N)	EX	$4.7~\mathrm{k}\Omega$	$47~\mathrm{k}\Omega$
• UNR221T	(UN221T)	EZ	$22~\mathrm{k}\Omega$	$47~\mathrm{k}\Omega$
• UNR221V	(UN221V)	FD	$2.2~\mathrm{k}\Omega$	$2.2~k\Omega$
• UNR221Z	(UN221Z)	FF	$4.7~\mathrm{k}\Omega$	$22~k\Omega$

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V _{CBO}	50	V	
Collector-emitter voltage (Base open)	V _{CEO}	50	V	
Collector current	I_C	100	mA	
Total power dissipation	P_{T}	200	mW	
Junction temperature	T_{j}	150	°C	
Storage temperature	T_{stg}	-55 to +150	°C	



Internal Connection



1

\blacksquare Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)		V_{CBO}	$I_C = 10 \ \mu A, I_E = 0$	50			V
Collector-emitter voltage (Base open)		V _{CEO}	$I_C = 2 \text{ mA}, I_B = 0$	50			V
Collector-base c	utoff current (Emitter open)	I_{CBO}	$V_{CB} = 50 \text{ V}, I_{E} = 0$			0.1	μΑ
Collector-emitte	r cutoff current (Base open)	I_{CEO}	$V_{CE} = 50 \text{ V}, I_{B} = 0$			0.5	μΑ
Emitter-base	UNR2210/2215/2216/2217	I_{EBO}	$V_{EB} = -6 \text{ V}, I_C = 0$			0.01	mA
cutoff current	UNR2213					0.1	
(Collector open)	UNR2212/2214/221D/ 221E/221M/221N/221T					0.2	
	UNR221Z					0.4	
	UNR2211					0.5	
	UNR221F/221K					1.0	
	UNR2219					1.5	
	UNR2218/221L/221V					2.0	
Forward current	UNR221V	h_{FE}	$V_{CE} = 10 \text{ V}, I_{C} = 5 \text{ mA}$	6		20	_
transfer ratio	UNR2218/221K/221L			20			
	UNR2219/221D/221F			30			
	UNR2211			35			
	UNR2212/221E			60			
	UNR221Z			60		200	
	UNR2213/2214/221M			80			
	UNR221N/221T			80		400	
	UNR2210*/2215*/2216*/2217*			160		460	
Collector-emi	tter saturation voltage	V _{CE(sat)}	$I_C = 10 \text{ mA}, I_B = 0.3 \text{ mA}$			0.25	V
UNR221V			$I_C = 10 \text{ mA}, I_B = 1.5 \text{ mA}$				
Output voltage high-level		V _{OH}	$V_{CC} = 5 \text{ V}, V_{B} = 0.5 \text{ V}, R_{L} = 1 \text{ k}\Omega$	4.9			V
Output voltage	e low-level	V _{OL}	$V_{CC} = 5 \text{ V}, V_{B} = 2.5 \text{ V}, R_{L} = 1 \text{ k}\Omega$			0.2	V
	UNR2213/221K		$V_{CC} = 5 \text{ V}, V_B = 3.5 \text{ V}, R_L = 1 \text{ k}\Omega$				
	UNR221D		$V_{CC} = 5 \text{ V}, V_{B} = 10 \text{ V}, R_{L} = 1 \text{ k}\Omega$				
	UNR221E		$V_{CC} = 5 \text{ V}, V_{B} = 6 \text{ V}, R_{L} = 1 \text{ k}\Omega$				
Transition frequency		f_T	$V_{CB} = 10 \text{ V}, I_E = -2 \text{ mA}, f = 200 \text{ MHz}$		150		MHz
Input resistance	UNR2218	R_1		-30%	0.51	+30%	kΩ
	UNR2219				1.0		
	UNR221M/211V				2.2		
	UNR2216/221F/221L/ 221N/221Z				4.7		
	UNR2211/2214/2215/221K				10	1	
	UNR2212/2217/221T				22	1	
UNR2210/2213/221D/221E					47	1	

 $Note) \ 1. \ Measuring \ methods \ are \ based \ on \ JAPANESE \ INDUSTRIAL \ STANDARD \ JIS \ C \ 7030 \ measuring \ methods \ for \ transistors.$

2. *: Rank classification

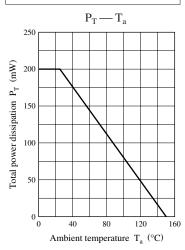
Rank	Q	R	S	No-rank
h _{FE}	160 to 260	210 to 340	290 to 460	160 to 460

■ Electrical Characteristics (continued) $T_a = 25$ °C ± 3 °C

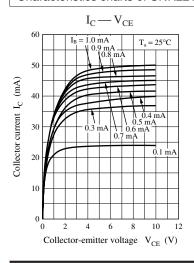
Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Resistance ratio	UNR221M	R ₁ /R ₂			0.047		_
	UNR221N				0.1		
	UNR2218/2219			0.08	0.10	0.12	
	UNR221Z				0.21		
	UNR2214			0.17	0.21	0.25	
	UNR221T				0.47		
	UNR221F			0.37	0.47	0.57	
	UNR221V				1.0		
	UNR2211/2212/2213/221L			0.8	1.0	1.2	
	UNR221K			1.70	2.13	2.60	
	UNR221E			1.70	2.14	2.60	
	UNR221D			3.7	4.7	5.7	

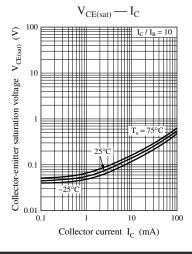
Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

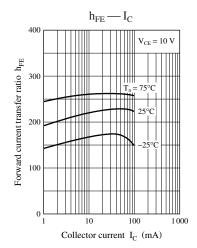
Common characteristics chart



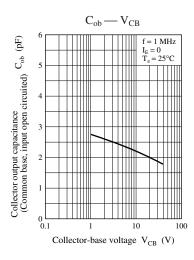
Characteristics charts of UNR2210

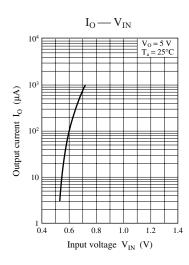


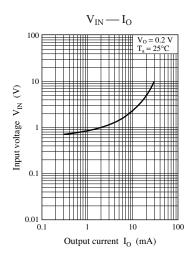


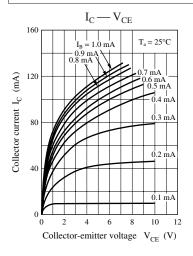


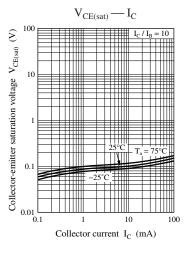
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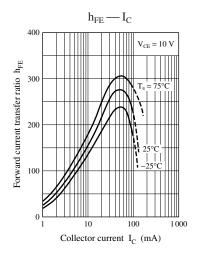


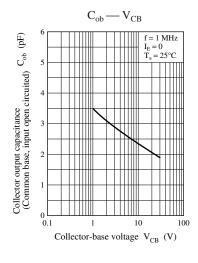


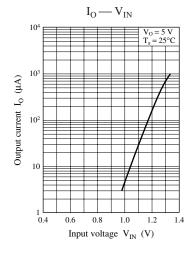


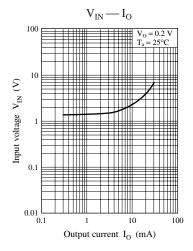




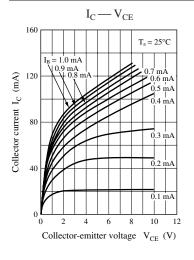


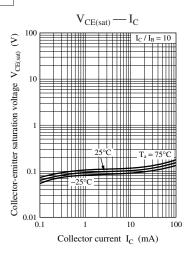


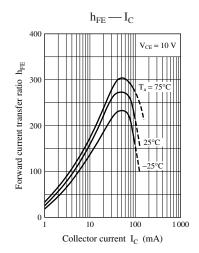


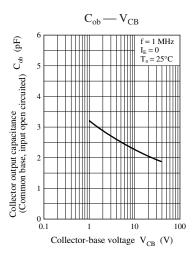


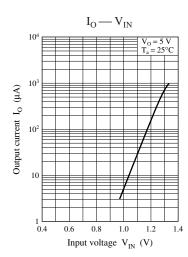
Characteristics charts of UNR2212

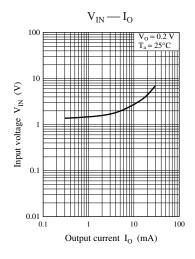


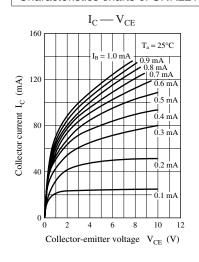


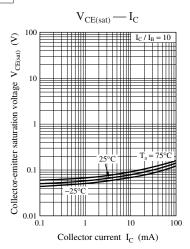


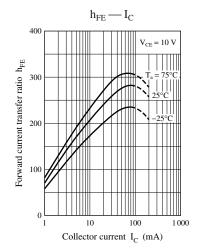


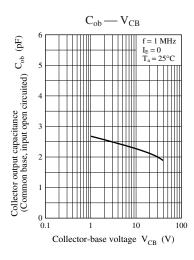


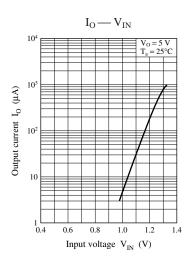


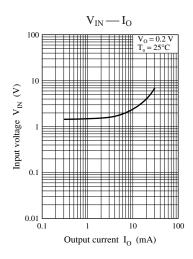


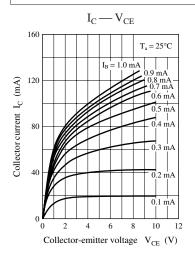


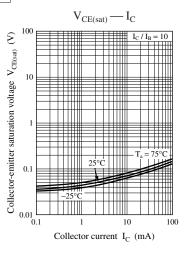


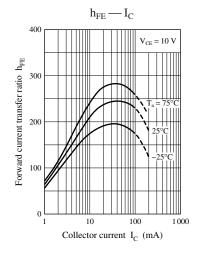


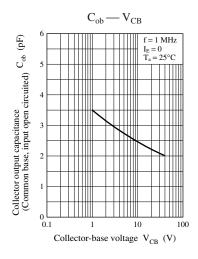


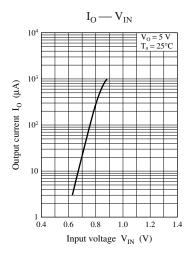


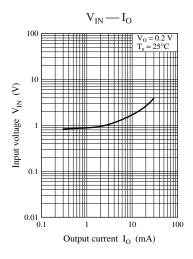




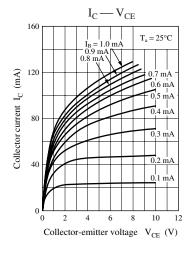


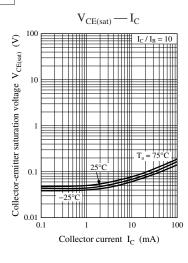


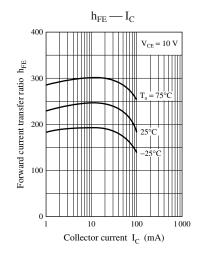


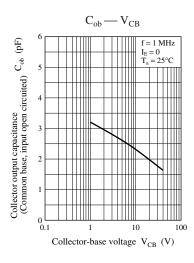


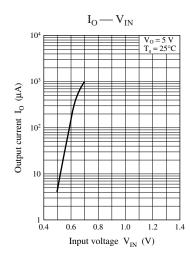
Characteristics charts of UNR2215

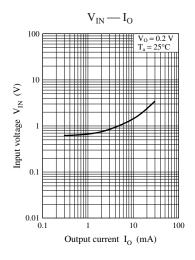


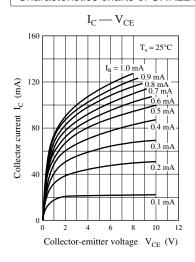


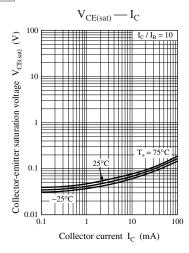


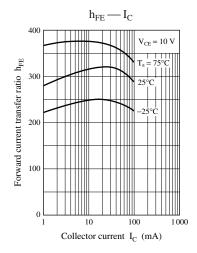


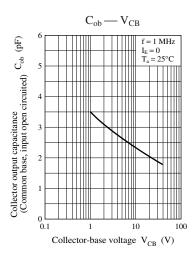


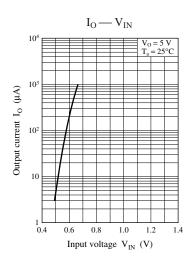


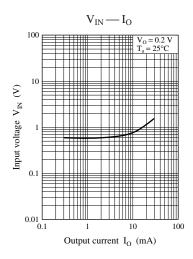


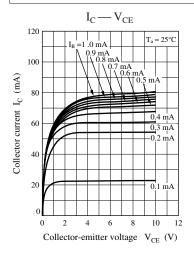


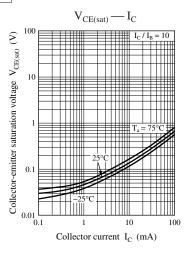


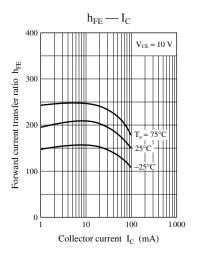


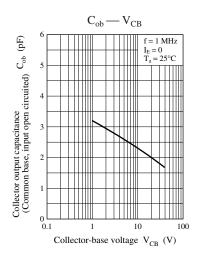


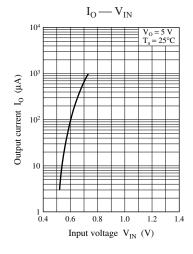


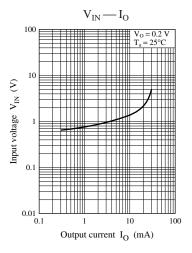




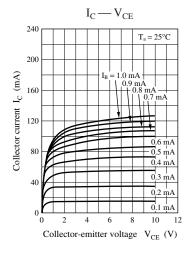


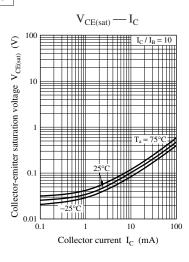


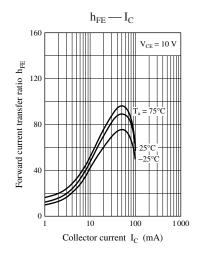


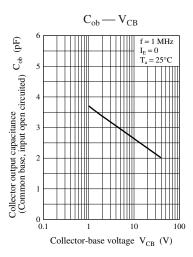


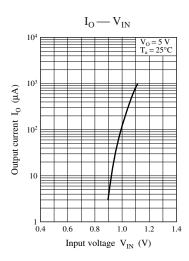
Characteristics charts of UNR2218

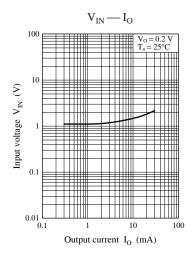


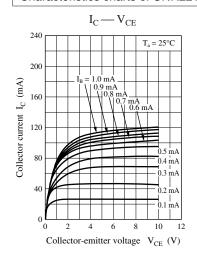


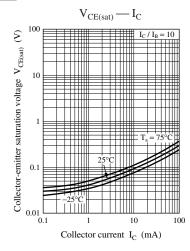


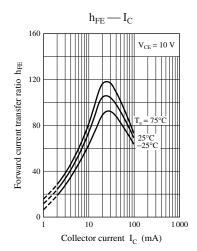


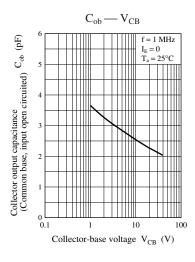


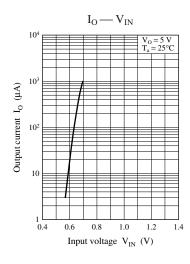


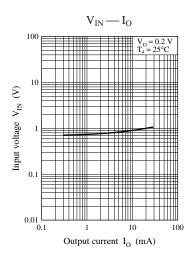


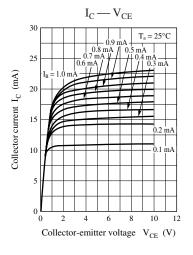


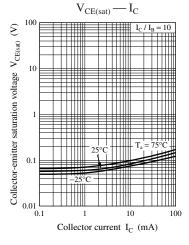


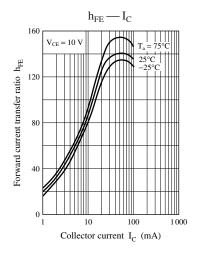


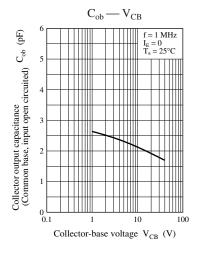


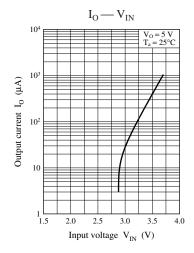


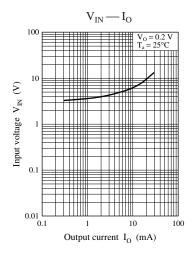




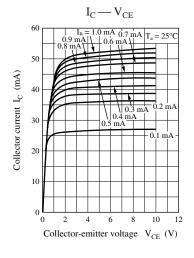


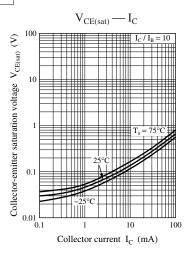


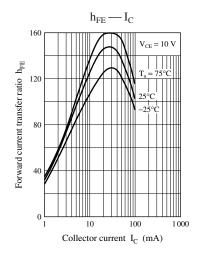


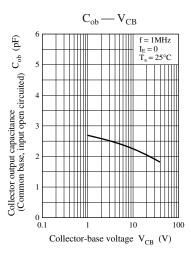


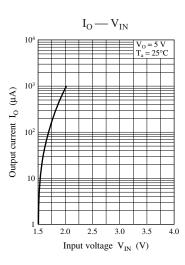
Characteristics charts of UNR221E

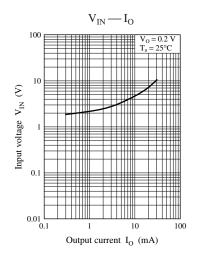


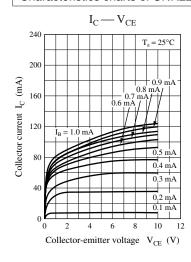


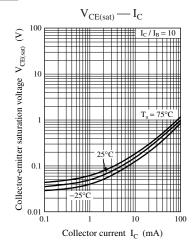


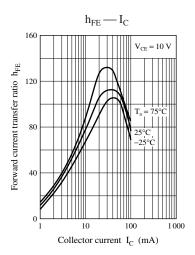


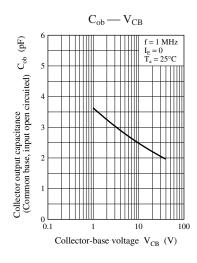


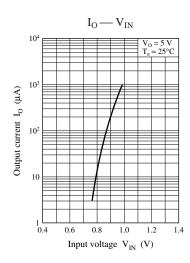


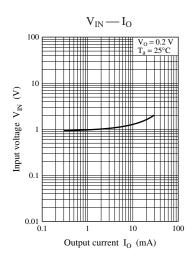


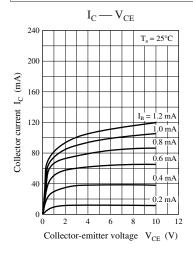


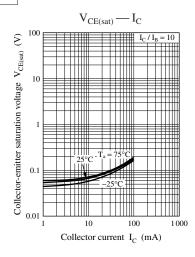


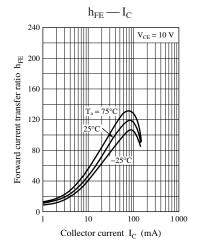


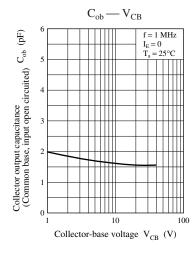


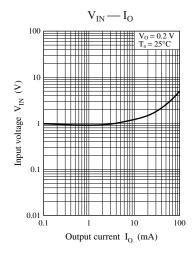




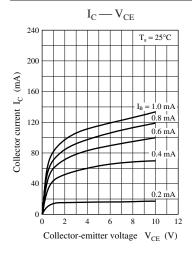


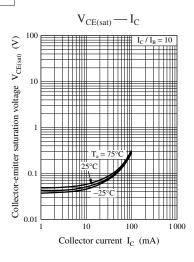


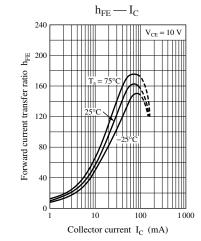


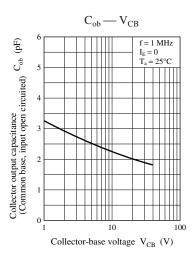


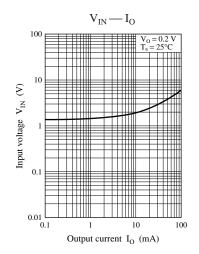
Characteristics charts of UNR221L



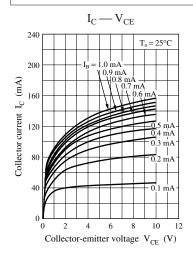


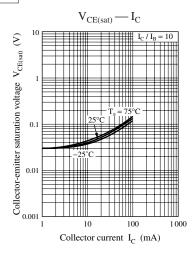


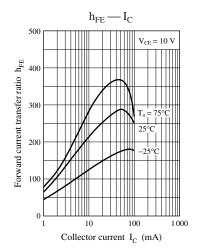




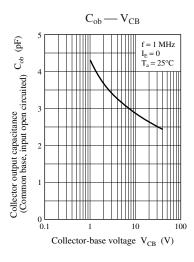
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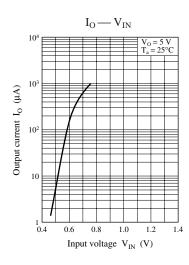


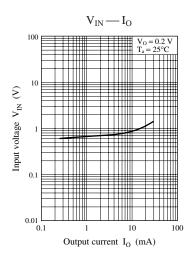


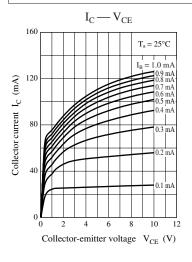


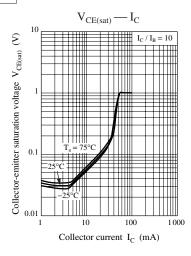
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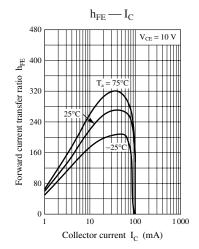


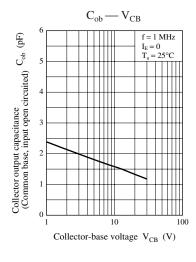


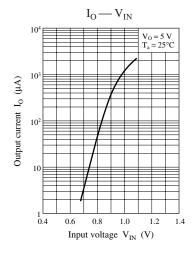


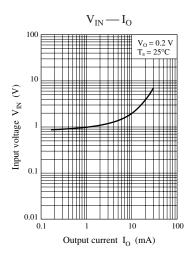




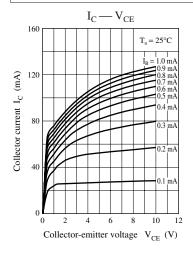


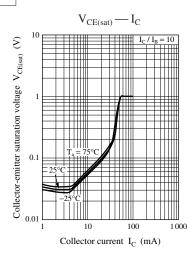


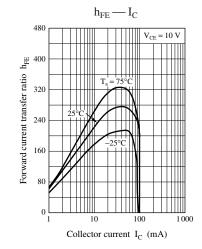


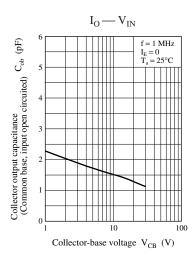


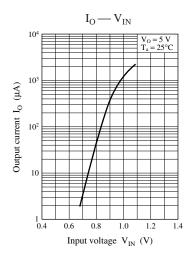
Characteristics charts of UNR221T

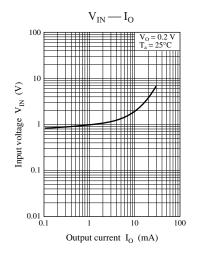


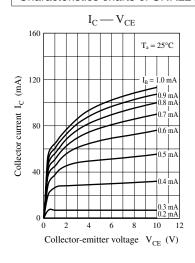


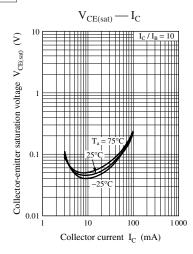


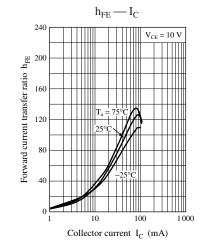


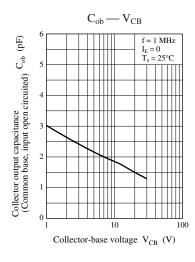


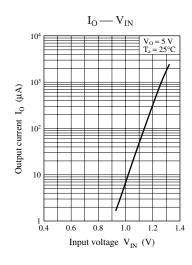


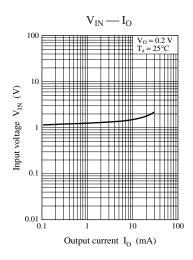


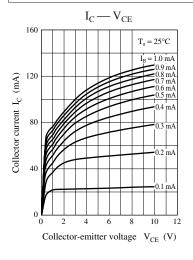


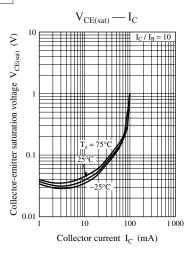


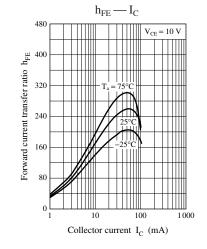


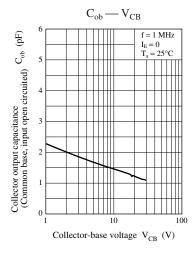


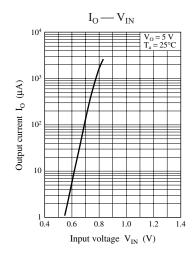


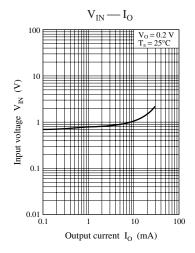












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